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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

Luis Trejo

Serial No.: 09/961,165

Filed: 09/21/01

For: Method for Controlling Wire Balls in Electronic Bonding

Docket No.: TI-21129

Conf. No.: 4601

Examiner: Nguyen, D. D.

Art Unit: 3729

Amendment under 37 CFR 1.115

Commissioner of Patents
P.O. Box 1450
Alexandria, VA 22313-1450

<p>CERTIFICATION OF FACSIMILE TRANSMISSION</p> <p>I hereby certify that the following papers are being transmitted by facsimile to the U.S. Patent and Trademark Office at 703-872-9306 on <u>8-25-04</u>:</p> <p><i>Tommy Chambers</i> Tommy Chambers</p>
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Dear Sir:

Responsive to the Office Action mailed May 28, 2004 in connection with the above identified application, Applicants respectfully submit the following amendments and remarks.

To: Technology Unit: 3729
Facsimile Number: 703-872-9306

Total Pages Sent 9

From: W. Daniel Swayze, Jr.
Texas Instruments Incorporated
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Tommie Chambers

August 25, 2004
Date

<input checked="" type="checkbox"/> FACSIMILE COVER SHEET	<input checked="" type="checkbox"/> AMENDMENT (8 Pages)
<input type="checkbox"/> NEW APPLICATION	<input type="checkbox"/> EOT (# Month)
<input type="checkbox"/> DECLARATION (# Pages)	<input type="checkbox"/> NOTICE OF APPEAL
<input type="checkbox"/> ASSIGNMENT (# Pages)	<input type="checkbox"/> APPEAL (# Pages)
<input type="checkbox"/> FORMAL DRAWINGS	<input type="checkbox"/> ISSUE FEE (# Pages)
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<input type="checkbox"/> CONTINUATION APP'N (# Pages)	
<input type="checkbox"/> DIVISIONAL APP'N	
NAME OF INVENTOR(S): Trejo	
TITLE OF INVENTION: METHOD FOR CONTROLLING WIRE BALLS IN ELECTRONIC BONDING	
TI FILE NO.: TI-21129	DEPOSIT ACCT. NO.: 20-0668
FAXED: 08/25/2004 DUE: 08/28/2004 ATTY/SEC'Y: WDS/ylc	
RECEIPT DATE & SERIAL NO.: Serial No.: 09/961,165 Filing Date: 9/21/2001	

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